



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Salman Akram

Serial No.: 10/791,191

Filed: March 2, 2004

For: METHOD OF IMPROVING COPPER

INTERCONNECTS OF

SEMICONDUCTOR DEVICES FOR

**BONDING** 

**Confirmation No.:** 1968

Examiner: A. Roman

Group Art Unit: 2812

Attorney Docket No.: 2269-3854.3US

(98-0854.03/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

December 7, 2006

Leta M. Howard

Name (Type/Print)

## <u>AMENDMENT UNDER 37 C.F.R. §1.116</u>

Mail Stop AF Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Final Office Action mailed October 10, 2006, the three-month shortened statutory period for response to which expires on December 10, 2006. This response is submitted on or before two months from the mailing date of the Final Office Action.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.